



FS0203

SCR

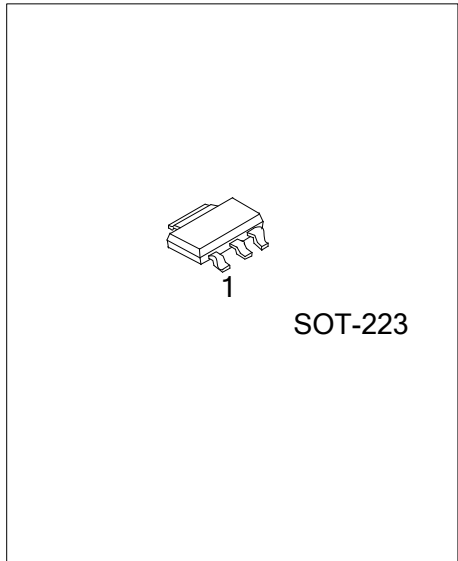
SURFACE MOUNT SCR

DESCRIPTION

The UTC **FS0203** is a surface mount SCR, it uses UTC's advanced technology to provide customers with high gate sensitivity, etc.

FEATURES

* High gate sensitivity



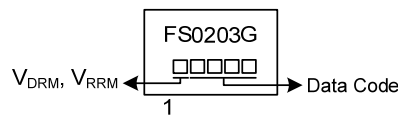
ORDERING INFORMATION

Ordering Number	Package	Pin assignment			Packing
		1	2	3	
FS0203G-x-AA3-R	SOT-223	K	A	G	Tape Reel

Note: Pin Assignment: K: Cathode A: Anode G: Gate

<p>FS0203G-x-AA3-R</p> <ul style="list-style-type: none"> (1) Packing Type (2) Package Type (3) V_{DRM}, V_{RRM} (4) Green Package 	<ul style="list-style-type: none"> (1) R: Tape Reel (2) AA3 : SOT-223 (3) 2: 200V, 4: 400V, 6: 600V, 8: 800V, 9:900V (4) G: Halogen Free and Lead Free
--	--

MARKING



■ ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT
Repetitive Peak Off State Voltage ($R_{GK}=1k\Omega$)	V_{DRM}, V_{RRM}	200	V
		400	V
		600	V
		800	V
		900	V
Average On-State Current (Note 1)	$I_{T(AV)}$	1.25	A
On-State Current (Note 1)	$I_{T(RMS)}$	0.8	A
Non-Repetitive On-State Current	I_{TSM}	25	A
		22.5	A
I^2t Value for Fusing	I^2t	2.5	A^2s
Peak Reverse Gate Voltage	V_{GRM}	8	V
Peak Gate Current	I_{GM}	1.2	A
Peak Gate Power	P_{GM}	3	W
Average Gate Power Dissipation	$P_{G(AV)}$	0.2	W
Operating Junction Temperature	T_J	-40~+125	$^{\circ}C$
Storage Junction Temperature	T_{STG}	-40~+150	$^{\circ}C$
Soldering Temperature	T_{SLD}	260	$^{\circ}C$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. With $5cm^2$ copper ($e=35\mu m$) surface under tab.

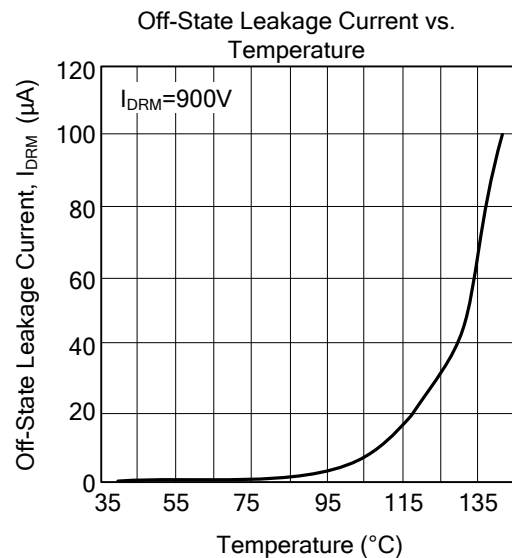
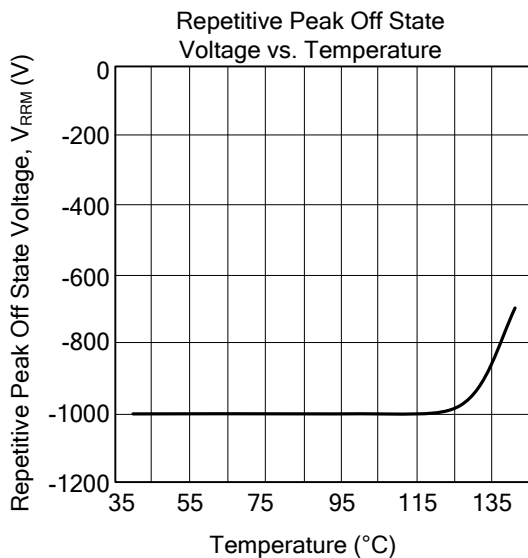
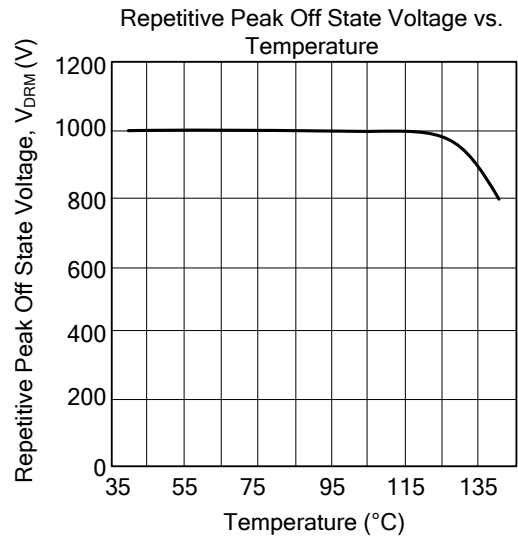
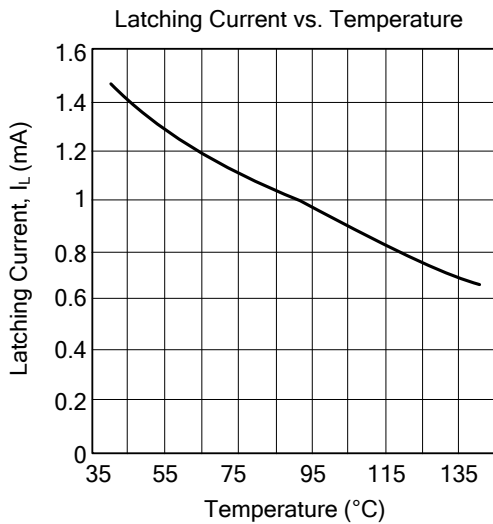
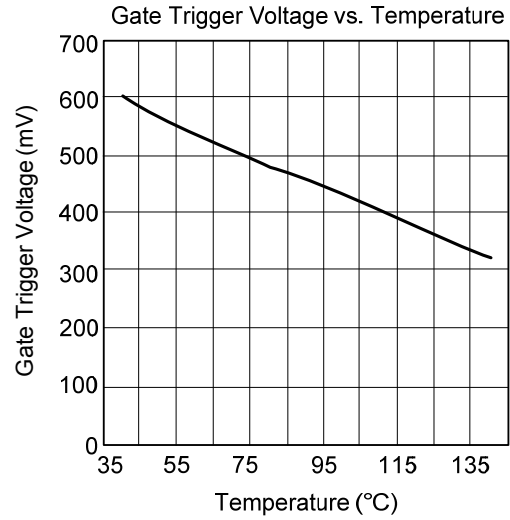
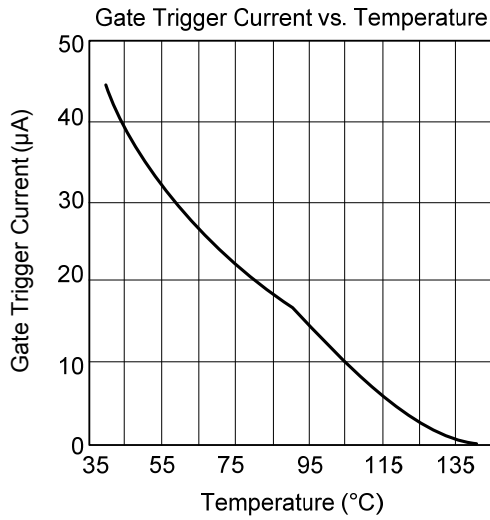
■ THERMAL RESISTANCES

PARAMETER	SYMBOL	RATINGS	UNIT
Junction-Leads for DC	θ_{JL}	25	$^{\circ}C/W$
Junction to Ambient	θ_{JA}	60	$^{\circ}C/W$

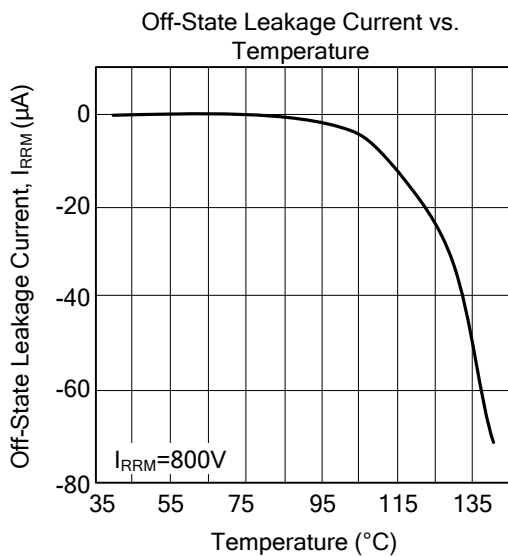
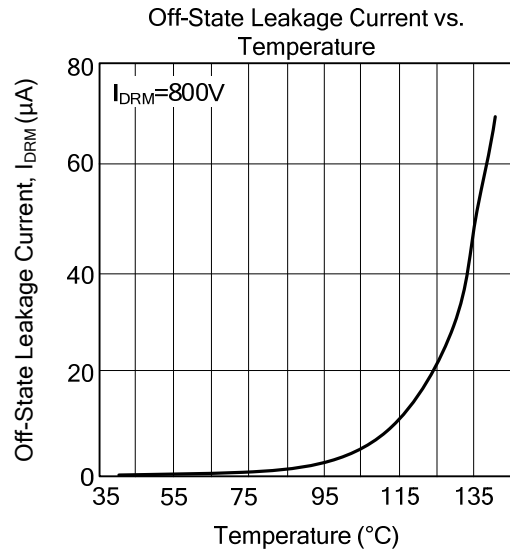
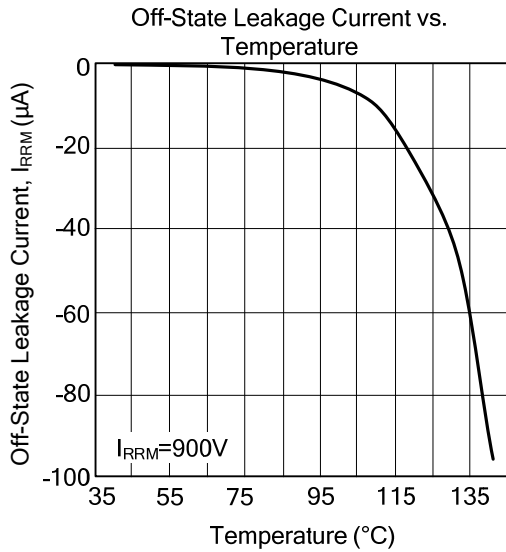
■ ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Off-State Leakage Current	I_{DRM}/I_{RRM}	$V_D=V_{DRM}, R_{GK}=1K\Omega, T_J=125^{\circ}C$			500	μA
		$V_R=V_{RRM}, T_J=25^{\circ}C$			5	μA
On-State Voltage	V_{TM}	at $I_T=1.6A, t_p=380\mu s, T_J=25^{\circ}C$			1.45	V
On-State Threshold Voltage	$V_{T(O)}$	$T_J=125^{\circ}C$			0.9	V
Dynamic Resistance	R_D	$T_J=125^{\circ}C$			150	$m\Omega$
Gate Trigger Current	I_{GT}	$V_D=12V_{DC}, R_L=140\Omega, T_J=25^{\circ}C$	20		200	μA
Gate Trigger Voltage	V_{GT}	$V_D=12V_{DC}, R_L=140\Omega, T_J=25^{\circ}C$			0.8	V
Gate Non-Trigger Voltage	V_{GD}	$V_D=V_{DRM}, R_L=3.3K\Omega, R_{GK}=1K\Omega, T_J=125^{\circ}C$	0.1			V
Holding Current	I_H	$I_T=50mA, R_{GK}=1K\Omega, T_J=25^{\circ}C$			5	mA
Latching Current	I_L	$I_G=1mA, R_{GK}=1K\Omega, T_J=25^{\circ}C$			6	mA
Critical Rate of Rise of Off-State Voltage	dv/dt	$V_D=67\% \times V_{DRM}, R_{GK}=1K\Omega, T_J=125^{\circ}C$	20			V/ μs
Critical Rate of Current Rise	di/dt	$I_G=2 \times I_{GT}, T_R \leq 100ns, F=60Hz, T_J=125^{\circ}C$	50			A/ μs

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.